

Article

Surface Functionalization of TiO₂ Nanotubes Modified with a Thin Film of BiFeO₃

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Abstract: The atomic layer deposition method allows for the production of a thin film with a high aspect ratio on the uneven surface of titanium dioxide nanotubes TiO₂(Nt). A modified BiFeO₃/TiO₂(Nt)/Ti (BFOT) structure with controllable electrical characteristics was obtained. BFOT possesses both ferroelectric and semiconductor properties with nonlinear conductivity dependent on the magnitude and duration of the voltage supply. Analysis of the temperature dependence of charge variation showed leakage currents in the BFOT structure due to the capture and release of charge carriers from defect levels. Surface modification of nanotubes with the multiferroic BiFeO₃ allows for the creation of semiconductors with adaptive functional properties.

Keywords: BiFeO₃; TiO₂; nanotubes; resistive switching; surface functionalization; ferroelectric



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1. Introduction

Improving materials for resistive switching devices and field-effect transistors based on ferroelectrics is closely related to optimizing the surfaces of these materials [1–5]. There is growing interest in combining these elements as field-effect transistors based on TiO₂ memristors with a programmable set/reset for neuromorphic computing [6]. Adding functionality to control the characteristics of memristive structures is a promising strategy for improving such devices. From the perspective of memory universality, it should have an unlimited number of write/read cycles and low power consumption and cost, and provide high information density and the potential for further scaling [7,8]. Ferroelectric (FeRAM) and resistive (ReRAM) memory are considered promising candidates for creating next-generation memory devices that meet the above requirements. From this point of view, the multiferroic BiFeO₃ (BFO), which combines the magnetoelectric effect and the resistive switching effect (RS) at low voltage values, has recently attracted great interest [9]. Thin BFO films, both epitaxial and polycrystalline, due to their excellent properties [10,11], such as residual polarization P_r , reverse piezoelectric effect, and high Curie temperature $T_C = 820\text{--}850\text{ }^\circ\text{C}$, are promising materials for resistive switching devices.

It has been noted that structures based on BFO have high leakage currents [12]. A reduction in leakage currents can be achieved through various methods, including creating interfaces with other materials [12]. Another way is through doping BFO with Mn [13], or Co and Ti [14]. Doping with titanium reduces leakage currents, but destroys the piezoelectric properties as it is impossible to achieve coercive field strength. Leakage currents are considered undesirable in thin film ferroelectrics when used in memory devices. However, controlling leakage currents is a key feature that plays a role in the memory process in memristive structures [15]. Creating structures with the ability to control leakage currents and electrical polarization can be interesting for the field of creating field-effect transistors based on ferroelectrics and in applications using artificial synapses that approximate

natural analogs. Titanium oxide can be considered a model material for resistive switching devices [16]. Phase transformations in TiO_2 can create various conductivity regions, including biased conductivity [17].

ALD technology allows for the production of functional layers on surfaces, including polymers [18]. The thinness of the layers allows for a reduction in their crack resistance [19]. Reconfigurable flexoelectricity, caused by bending a flexible substrate, induces non-uniform distortion of the BFO lattice, affecting the inversion asymmetry of the film [20]. Thus, multi-level conductivity is achieved through the connection between the flexoelectric and ferroelectric properties of the film [21]. The multi-level conductivity of the BFOT structure enables its use as an analog memristive structure [22].

Using two oxides with different ion potentials can induce a positive surface charge and reduce the work function of the original material with mixed conductivity. Surface dipoles in ferroelectrics caused by changes in the energy landscape can redistribute electron charge densities. Charge redistribution, in turn, can contribute to geometric surface reorientation.

2. Materials and Methods

BFO films were grown using a sequentially pulsed chemical vapour deposition method on a titanium plate substrate, which had previously been coated with a $\text{TiO}_2(\text{Nt})$ film in the form of vertical nanotubes using an electrochemical method. In the absence of the use of quartz microbalances, the adopted method cannot be demonstrated to be strictly an atomic layer deposition (ALD) one, but for the sake of simplicity, we will use the acronym ALD in the following. This method enables the growth of films with 100% conformity, which is important for the chosen system. The thickness of the $\text{TiO}_2(\text{Nt})$ layer was approximately 2.5 μm . Tris(1-methoxy-2-methyl-2-propoxy) bismuth ($\text{Bi}(\text{mmp})_3$) and ferrocene ($\text{Fe}(\text{cp})_2$) were used as precursor sources. In the ALD process, precursors were delivered to the chamber using a 99.999% pure N_2 carrier gas. The temperature range for $\text{Bi}(\text{mmp})_3$ evaporation was 135–145 $^\circ\text{C}$, and the temperature for ferrocene evaporation was 90 $^\circ\text{C}$. The ALD BiO_x consisted of a 1.2 s precursor pulse of $\text{Bi}(\text{mmp})_3$, followed by a 5 s N_2 . Then, an O_3 pulse was applied for 5 s, followed by purging of the chamber with N_2 for 15 s. Then, ALD FeO_x cycles were applied. The duration of the $\text{Fe}(\text{C}_5\text{H}_5)_2$ precursor pulse was 2 s, and the number of subcycles for each precursor was 90. Throughout the experiment, the input and output gas lines were maintained at a temperature of 150 $^\circ\text{C}$. The substrate was located 4–5 cm from the entrance. The diameter of the reactor was 20 cm. The temperature window for the $\text{Bi}(\text{mmp})_3$ precursor was in the range of 200–300 $^\circ\text{C}$, and the saturation mass growth started at 1.0 s [23]. Using ferrocene, the optimal temperature for the self-limiting reaction with ozone was 200 $^\circ\text{C}$ [24]. In an earlier study, a more linear region can be identified in the temperature window of 210–260 $^\circ\text{C}$, and the saturation mass growth was achieved at 2 s [25]. When producing BFO in a single technological cycle with alternating precursors, a linear growth value of the BFO film was achieved in the temperature range of 250–330 $^\circ\text{C}$ [26]. Based on these considerations, a growth temperature of 250 $^\circ\text{C}$ was chosen for this experiment.

Afterward, the obtained samples underwent thermal treatment in air at a temperature of 660 $^\circ\text{C}$ for 60 min. Due to the diffusion into the pores of the nanotube array, it is difficult to accurately measure the thickness of the film. The approximate thickness of the film is around 90 nm. For electrical measurements, platinum contacts were applied to the surface of the structure using magnetron sputtering, with the titanium substrate serving as the bottom electrode. Figure 1 shows the diagram of the process of layer-by-layer formation of Bi-O/Fe-O film on the surface of $\text{TiO}_2(\text{Nt})/\text{Ti}$ substrate.

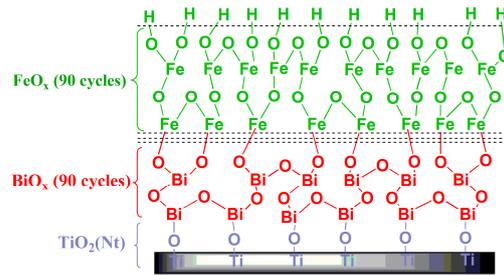


Figure 1. Scheme of atomic layer deposition of a heterostructure in the $\text{BiO}_x/\text{FeO}_x/\text{TiO}_2(\text{Nt})/\text{Ti}$ system.

Characterization of the obtained heterostructures was performed using scanning electron microscopy (SEM) with a Magellan (Thermo Fisher Scientific, Hillsboro, OR, USA) scanning electron microscope. X-ray diffraction (XRD) studies were conducted using an Empyrean PANalytical X-ray diffractometer (Almelo, the Netherlands) in the radiation of a copper anode with a nickel filter, with radiation wavelength $\lambda(\text{Cu}_{K\alpha}) = 0.154051$ nm. Raman spectra were examined with a Laser Raman 3D scanning confocal microscope (Ntegra Spectra, Moscow, Russia) using a green laser (532 nm) with a spot size of $1 \mu\text{m}$ and a resolution of 0.5 cm^{-1} . The surface was examined using piezoresponse force microscopy (PFM) methods, such as variation in atomic force microscopy (AFM). Electrical measurements were performed using a Keithley 2400 source measure unit. The voltage sweep for the current–voltage (I – V) measurements was a bi-directional triangular signal ($0 \text{ V} \rightarrow 15 \text{ V} \rightarrow 0 \text{ V} \rightarrow -15 \text{ V} \rightarrow 0 \text{ V}$). At each point of the voltage sweep, the measurement was conducted using the following scheme: voltage generation–delay (waiting)–current measurement. The delay time varied from 0.01 s to 1 s. The normal measurement speed option of the instrument was chosen. The measurement speed option was normal and corresponded to the integration time of the incoming signal 0.1 s. The sample temperature was set by a resistive heater and monitored by a type-K thermocouple.

3. Results

3.1. Structural Characteristics

The surface of the nanotubes has a large area both on the surface and on the sides where pores remain. The ALD method allows for high aspect ratio coverage of almost all open areas. Figure 2 shows the surface of the nanotubes before and after the deposition of the BFO film. As can be seen, the surface is covered with an array of vertically oriented $\text{TiO}_2(\text{Nt})$ with a diameter of around 100–200 nm and a wall thickness of approximately 10 nm. This morphology of $\text{TiO}_2(\text{Nt})$ allows for a significantly increased surface area compared to a titanium oxide film. Consequently, the number of active centers for interaction during the ALD process with the BFO film is also increased.

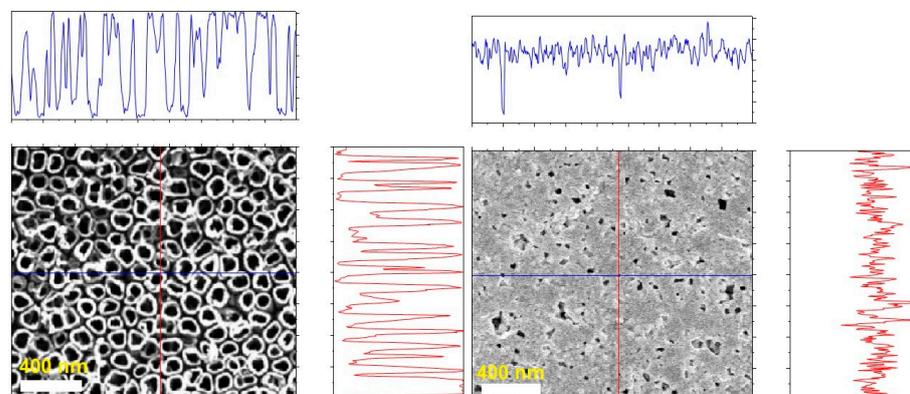


Figure 2. SEM of surfaces before and after application of BFO film, vertical and horizontal profile along a line showing the closure of almost all pores.

From Figure 2, it can be seen that almost the entire uneven surface of the nanotubes is covered by a film. However, there are still pores with sizes up to 60 nm after coating with the BFO film. As can be seen from the profiles, the film even penetrates inside the nanotubes, filling them from the inside.

Figure 3 shows the XRD of $\text{TiO}_2(\text{Nt})/\text{Ti}$ substrate with a nanotube array and the obtained heterostructure BFOT. As can be seen from Figure 3, many peaks overlap due to the large number of phases. During thermal treatment of the structure at the interface, a phase transformation from anatase to rutile occurs (A, R designations of peaks in Figure 3). After annealing at 660 °C, an initial phase of anatase partially transformed into the rutile phase with the characteristic diffraction peak at $2\theta = 27.7^\circ$ (110).

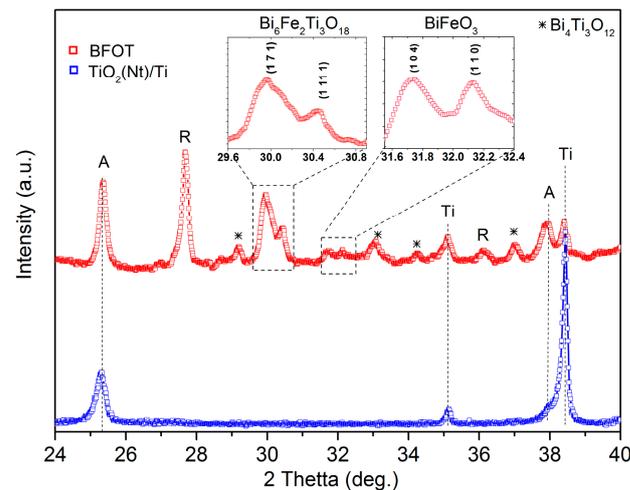


Figure 3. XRD patterns of $\text{TiO}_2(\text{Nt})/\text{Ti}$ (bottom) and BFOT (top). A—anatase; R—rutile; Ti—titanium; *— $\text{Bi}_4\text{Ti}_3\text{O}_{12}$; the tabs show the phases $\text{Bi}_6\text{Fe}_2\text{Ti}_3\text{O}_{18}$ and BiFeO_3 .

As can be seen from the XRD results in Figure 3, the peaks at 29.9° , 30.1° , 33.1° , 34.3° , and 37.2° correspond to the $\text{Bi}_4\text{Ti}_3\text{O}_{12}$ with Aba2 space group [27]. The peaks at 31.7° (104) and 32.1° (110) are attributed to the BiFeO_3 film structure with R3c space group, which is highlighted in the inset [28]. The peaks at 30.1° (171) and 30.4° (1 11 1) are related to the layered structure of $\text{Bi}_6\text{Fe}_2\text{Ti}_3\text{O}_{18}$ with Fmm2 space group [29].

Since Raman spectroscopy is sensitive to structural changes, it can provide valuable information about lattice properties and phase transitions. Figure 4 shows the Raman scattering spectra.

For comparison, the substrate spectra with an array of $\text{TiO}_2(\text{Nt})$ nanotubes in the anatase structure are presented. In the low-frequency range of the spectra (below 200 cm^{-1}), the characteristic modes correspond to the vibrations of Bi^{3+} ions in the $(\text{Bi}_2\text{O}_2)^{2+}$ layer and the vibrations of Bi^{3+} ions relative to oxygen octahedra. The high-frequency modes above 200 cm^{-1} characterize the bending and stretching modes of the BO_6 octahedra. Peaks 144 cm^{-1} , 396 cm^{-1} , 513 cm^{-1} , 634 cm^{-1} , respectively, belong to vibrations E_g , B_{1g} , A_{1g} , E_g the anatase TiO_2 crystal lattice [30]. The newly appearing shoulders at 469 cm^{-1} and 612 cm^{-1} refer to the partially disordered of the rutile TiO_2 structure [31]. The rutile phase is observed due to phase transformations at the boundary with the BFO film. In the high-frequency range above 400 cm^{-1} , all peaks are asymmetric, and they can be interpreted as a superposition of several closely spaced modes. The mode at 340 cm^{-1} corresponds to the twisting vibration of Ti/FeO_6 octahedra, while the modes at 567 cm^{-1} and 800 cm^{-1} are related to the stretching of octahedral chains $\text{O}-\text{Ti}/\text{Fe}$ between $(\text{Bi}_2\text{O}_2)^{2+}$ layers. The asymmetric peak with a mode in the range of 844 cm^{-1} corresponds to fully asymmetric valence vibrations of $\text{O}-\text{Ti}-\text{O}$ and $\text{O}-\text{Fe}-\text{O}$ bonds in Ti/FeO_6 octahedra [32]. The formation of phonon modes at 567 cm^{-1} and 706 cm^{-1} is due to the combination of stretching of the $\text{Bi}-\text{Fe}-\text{O}$ bond and octahedral bending. Peaks in the range of 221 cm^{-1} to

267 cm^{-1} correspond to the vibrations of Ti/FeO₆ octahedra in BFOT. Additionally, peaks characteristic of BFO and Bi₄Ti₃O₁₂ are observed. The multi-component nature of the BFOT compound formed at the film-substrate interface can change its properties in the interfacial region due to diffusion mechanisms. Dynamic phase transformations contribute to the nonlinearity of conductivity depending on the applied voltage, charge delivery time, and accumulation of defect levels.

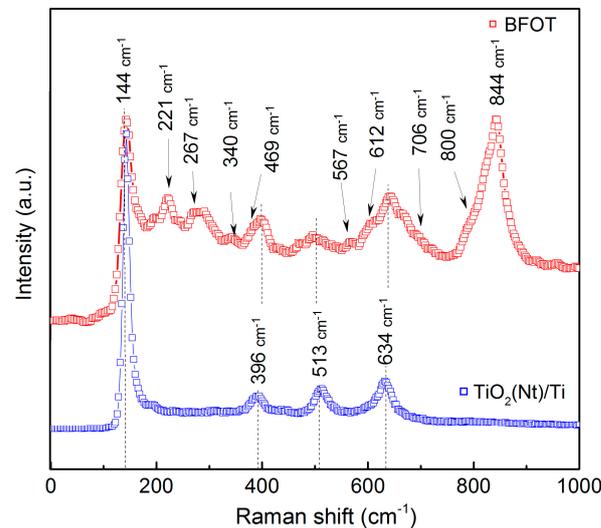


Figure 4. Raman spectra of the nanotube substrate (**bottom**) and the BFO film (**top**).

In the BFOT structure, resistance changes occur upon the application of voltage with the formation of phase boundaries and redistribution of oxygen vacancies. The presence of Fe and Ti ions in the structure with oxidation states different from the homogeneous crystalline structure induces oxygen vacancies necessary to maintain the electronic neutrality of the system. The formation of oxygen vacancies reduces intrinsic defects, which are well-known capture centers for carrier recombination. This effect promotes electron–hole separation. The appearance of Ti³⁺ is caused by Fe atoms partially replacing Ti atoms in TiO₆ octahedra. Similarly to the Fe³⁺ → Fe²⁺ transition, replacement upon Ti⁴⁺ → Ti³⁺ transition leads to an enhancement of ferroelectric residual polarization. Additionally, there is an enhancement of Bi 6s electron hybridization with 2p oxygen orbitals, which contributes to the generation and enhancement of hole mobility and shift of the valence band edge. Thus, upon the application of bias, non-uniform regions with different conductivity caused by redox processes in the material are formed.

Thermal treatment leads to a solid-phase chemical reaction in the near-surface region: $3\text{TiO}_2 + 2\text{Bi}_2\text{O}_3 \rightarrow \text{Bi}_4\text{Ti}_3\text{O}_{12}$. At concentrations of $n(\text{Bi})/n(\text{Ti}) > 1$ in the Bi₂O₃-TiO₂ system, compounds belonging to the family of layered phases are formed [33]. Due to titanium diffusion, a stable compound Bi₄Ti₃O₁₂ is formed [34]. In the Bi₂O₃-Fe₂O₃ system, the reaction proceeds due to mass transfer: $\text{Fe}_2\text{O}_3 + \text{Bi}_2\text{O}_3 \rightarrow 2\text{BiFeO}_3$. Thus, upon thermal treatment, intermediate layered structures where the presence of BFO determines the number of layers can be formed due to self-organization of the BiFeO₃-Bi₄Ti₃O₁₂ phase [35]. The interfaces in periodically arranged structures can be modulated by doping with various ions of alkaline earth or rare earth metals [36,37]. The transition between layers with different numbers of blocks is accompanied by stacking defects in the layer (Bi₂O₂)²⁺. The interfaces of such structures can create regions with morphotropic phase transitions [38]. Such regions are likely related to the substitution of Fe³⁺ ions in a narrow range of 0.58–0.65 for Ti⁴⁺ ions in octahedral cells [39]. The formation of such regions is also explained by the difference in ionic radii of iron and titanium, which is ~6%, leading to a displacement of these ions relative to (Bi₂O₂)²⁺ layers [40].

3.2. Electrical Characteristics

Next, we consider the change in conductivity and charge accumulation depending on the time the signal is applied. Figure 5 shows the current–voltage characteristics of the BFOT film structure measured at different voltage sweep rates (delay times). The presented I–V curves were obtained without prior electroforming of the sample. Figure 5a demonstrates that the sample’s current–voltage characteristics exhibit a hysteresis loop that passes through all four quadrants of the coordinates. As the voltage sweep rate increases, the hysteresis loop of the I–V slightly widens in the first and third quadrants due to an increase in the displacement current, which is determined as the time derivative of the electric displacement D [41]. Figure 5b shows the integral dependence of charge accumulation under positive and negative voltage polarities at different delay and release times. With an increase in the delay time up to 1 s, the current increases in both directions, which is characteristic of domain polarization.

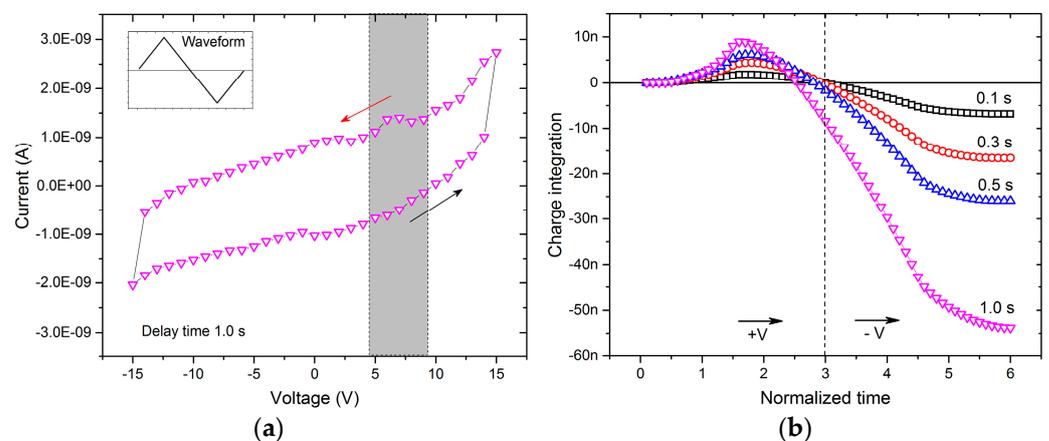


Figure 5. Current-voltage characteristic of the sample, arrows indicate the direction of voltage application, delay time 0.1 s (a). Dependence of the integral charge, normalized by time, measured with different delay times 0.1, 0.3, 0.5, 1.0 s (b).

The internal electric field is directed towards the external field, and at the point of intersection of the reverse I–V with the abscissa axis, it fully compensates for it. With further voltage reduction, the internal field prevails over the external one, and the current changes its direction to the opposite. The slight maximum at the initial part of the forward I–V for a delay time of 1.0 s is related to the switching of polarization domains in the ferroelectric along the external field. The BFOT possesses volumetric charge polarization due to its inhomogeneous dielectric structure, resulting in an internal field [16]. In turn, the internal field can influence the slope of the energy levels due to differences in the width of the forbidden zone, which varies in the range of 2.31–2.67 eV [42]. The phase transformation at the film-substrate interface creates defect regions and oxygen vacancies in the structure [35]. Such interface boundaries and defects can trap charge carriers under the application of an external field.

BFO exhibits piezoelectric properties, generating its own internal potential [43,44]. The film’s piezoelectric potential can increase depending on the applied displacement and light [45]. If the substrate has a bending property, mechanical stress can easily relax throughout its surface, creating non-uniform regions of voltage accumulation. This property of BFO is particularly useful for heterostructures with flexible substrates [46]. Figure 6 shows an SEM image of nanotube surfaces after deposition, where the film can press on the substrate and thereby spread out more free nanotubes.

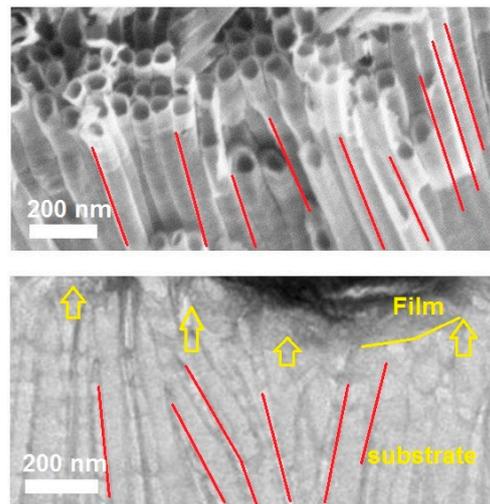


Figure 6. SEM image of nanotubes before (**top**) and after (**bottom**) deposition of the BFO film, the lines show how the $\text{TiO}_2(\text{Nt})$ nanotubes are deformed.

The calculation results show that TiO_2 (Nt) exhibits high values of Young's modulus (800 GPa) outside the [47], plane, but the planar mechanical response of TiO_2 (Nt) nanotube arrays is characterized by very low elastic moduli and significant damping [48]. Due to the surface's heterogeneity with nanotubes, the film covers unevenly in thickness. As shown in Figure 6, in the pits area where a thicker section of the film is present, pressure can create deformations and partially shift the array of nanotubes. Non-uniform voltage accumulation regions are formed in the structure at the film-substrate interface. Figure 7 shows the PFM surface of the sample when applying a voltage of different polarity. Without applying voltage, the sample partially has a charge on the surface (Figure 7a). Applying positive voltage to the surface further enhances piezopolarization (Figure 7b). As seen from the figure, the sample possesses ferroelectric properties. Due to the complex morphology of the surface, domain boundaries have potential heterogeneity. Negative potential reduces surface charge.

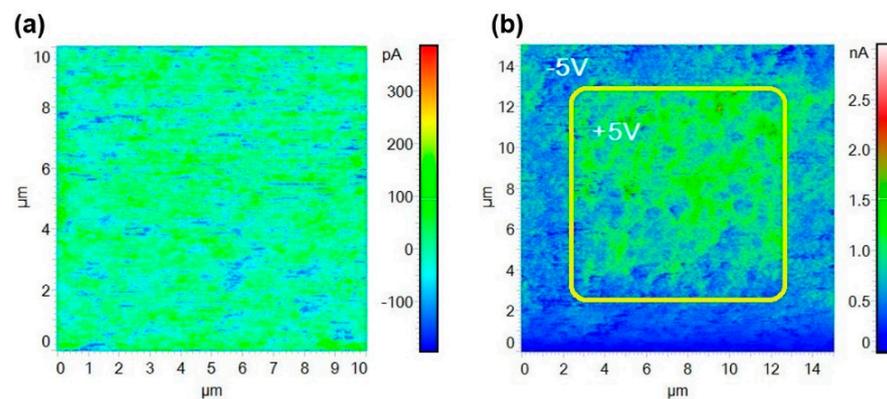


Figure 7. PFM of the film surface without applying voltage (a). When applying voltage 5V and -5V (b).

The charge moves through the inhomogeneities at the boundaries of the nanotubes, where the resistance is lower, vertically along the sample towards the bottom electrode. The surface remains partially positively charged. This indicates the polarization of domains in the surface film of BFO. To understand the mechanism of charge capture and release, we conducted temperature measurements. Figure 8 shows the dependence of I-V on temperature.

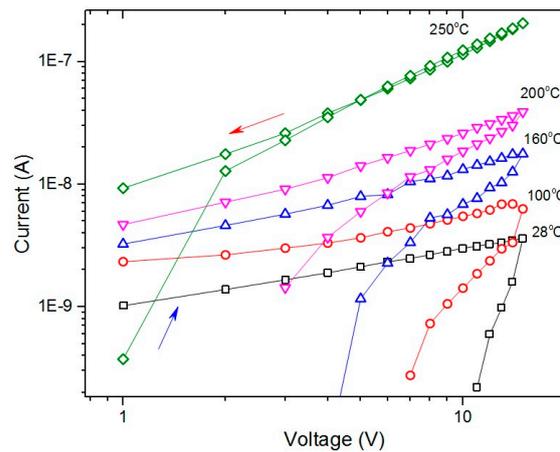


Figure 8. Current-voltage characteristics on a logarithmic scale at various temperatures, delay time $t = 0.1$ s.

As seen from the figure, as the temperature increases, the I–V curve’s hysteresis loop narrows along the ordinate axis, while the current values around the loop increase, and at $T = 250$ °C, the loop almost collapses into a line, and the current value at the end of the forward I–V increases by two orders of magnitude for $T = 28$ °C. The increase in conductivity with increasing temperature is due to an increase in carrier concentration [49]. In turn, increasing conductivity hinders polarization processes in the dielectric (ferroelectric) since these are competing mechanisms; the internal field in the sample weakens as it heats up, ultimately leading to the collapse of the I–V loop [50]. During the formation of conducting channels in a semiconductor state, the isolating layer of the ferroelectric undergoes a soft breakdown, which causes a sharp current jump with subsequent voltage change. It was found that the current increased while the voltage on the sample decreased, which excluded a hard breakdown in the microstructure of the dielectric. A characteristic feature of the sample’s $I(t)$ dependence on increasing temperature is the gradual decrease in current over time after applying a constant voltage with subsequent leveling off. The concept of the relaxation time of level filling τ determines the time that the current carrier spends at the trap energy level E_t and the time it takes to empty it after the activation process is turned off/on, generally being a function of temperature. The time τ is related to the trap energy E_t by the following relationship:

$$\tau = (\sigma v_T N)^{-1} \exp(E_t/kT)$$

where σ is the cross-section, v_T is the average relative velocity of charge thermal motion to the trap, and N is the concentration of traps (defects). During the formation of conducting channels in the semiconductor state, a soft breakdown occurs through the insulating layer, causing a sharp jump in current with subsequent voltage change [51]. It was found that the current increased while the voltage on the sample decreased, which excluded a hard breakdown in the microstructure of the dielectric. The increase and decrease in conductivity within the dielectric layer during the ascending and descending phases of the I–V occur due to the release of electrons at defect levels described by the Poole–Frenkel conduction mechanism [52]. Direct oscilloscope and pulsed measurements in low-resistance and intermediate states are needed for a more detailed assessment of level-filling relaxation time values.

4. Conclusions

The modification of the substrate surface of titanium dioxide nanotubes has shown a good phase interaction with the BFOT structure, which has controllable electrical characteristics. BFOT possesses both ferroelectric and semiconductor properties, with nonlinear conductivity dependent on the magnitude and duration of applied voltage. Temperature-

dependent I–V curves have shown charge redistribution in the sample. During mutual diffusion of $\text{Ti} \leftrightarrow \text{Fe}$ in the material, areas with non-uniform conductivity are formed. Structural defects and oxygen vacancies create levels in the forbidden band. These defects, in turn, participate in charge carrier capture and release processes. The increase and decrease in conductivity within the dielectric layer during the ascending and descending phases of the I–V curve occur due to the release of electrons from defect levels described by the Poole–Frenkel conduction mechanism.

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